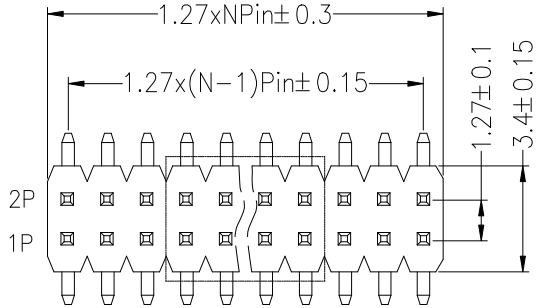
HSF RoHS

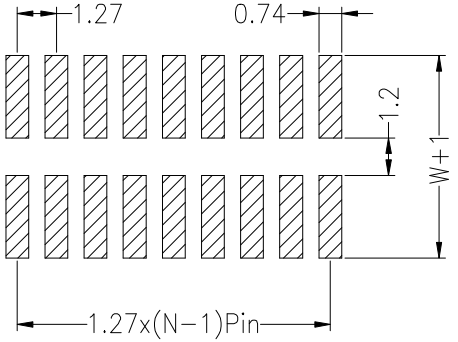
FILE NO :E362810

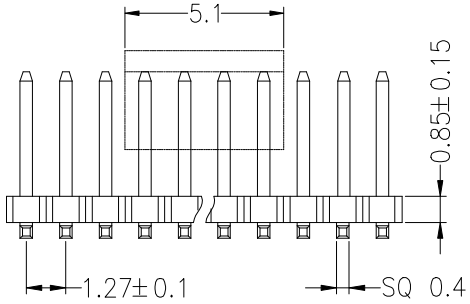
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

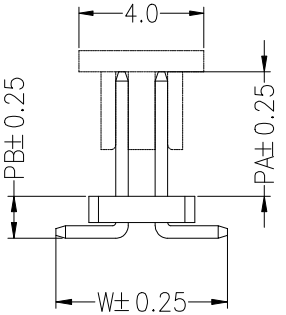
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)







Ordering Information

1408 12 XX X N XX M XXX X 0X

No.of Pins Per Row 2−50	Insulator Material Option C=BK−PA6T E=BK−PA9T F=BK−LCP	Post N=w/o post	Contact Plating G1:Gold Flash G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin	Pin Length	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap			

Dimension antitheses list			
ITEM	PA	PB	W
Standard	4.00	1.35	5.50

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A1	2018.10.19	塑胶件改良,侧面增加槽口	
A0	2012.04.19	NEW DRAWING	

OPERATION		DRAW	Liu Miao	18.10.19	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	140812XXXNXXMXXXX0X
TITLE:	1.27PH 2xnPin H0.85 SMT